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MOSFET - Power, Single N-Channel, TOLL

80 V, 1.7 mΩ, **241.3 A**

NVBLS1D7N08H

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- Lowers Switching Noise/EMI
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	80	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	۱ _D	241.3	А
Current $R_{\theta JC}$ (Notes 1, 3)	Steady	T _C = 100°C		170.6	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	237.5	W
R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$		118.7	
Continuous Drain	Steady	$T_A = 25^{\circ}C$	۱ _D	33	А
Current R _{θJA} (Notes 1, 2, 3)		$T_A = 100^{\circ}C$		23.3	
Power Dissipation	State	T _A = 25°C	PD	4.4	W
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		2.2	
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	197.9	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 21 A)			E _{AS}	1172	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.63	°C/W
Junction-to-Ambient - Steady State (Notes 1, 2)	R_{\thetaJA}	33.8	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

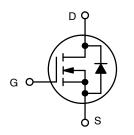
Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	1.7 m Ω @ 10 V	241.3 A

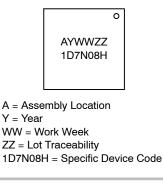


N-CHANNEL MOSFET



CASE 100CU

MARKING DIAGRAM



ORDERING INFORMATION

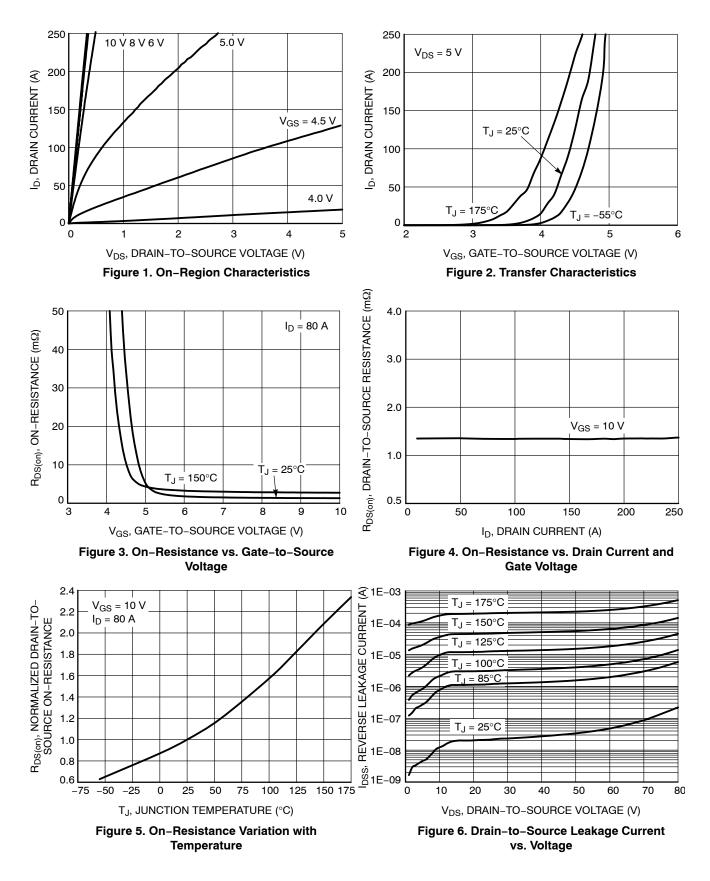
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

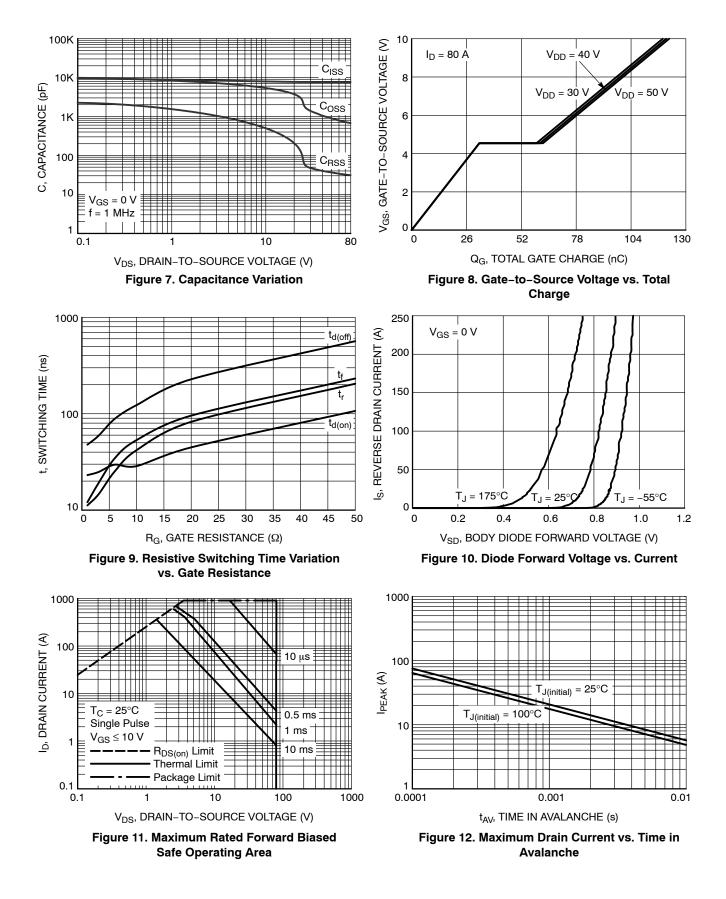
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				57		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$				10	
		$V_{DS} = 80 V$	T _J = 125°C			250 μA	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = 20 V				100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 479 μ A		2.0	2.9	4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	$I_D = 479 \ \mu A$, ref to $25^{\circ}C$			-7.3		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 80 A		1.29	1.7	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =5 V, I _D = 80 A			271		S
CHARGES, CAPACITANCES & GATE RES	SISTANCE						-
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 40 V			7675		pF
Output Capacitance	C _{OSS}				1059		
Reverse Transfer Capacitance	C _{RSS}				41		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 40 V; I _D = 80 A			121		nC V
Threshold Gate Charge	Q _{G(TH)}				19		
Gate-to-Source Charge	Q _{GS}				32		
Gate-to-Drain Charge	Q_{GD}				29		
Plateau Voltage	V _{GP}				4.5		
SWITCHING CHARACTERISTICS (Note 4))						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 40 V, I_{D} = 80 A, R_{G} = 6 Ω			29		ns
Rise Time	t _r				25		
Turn-Off Delay Time	t _{d(OFF)}				89		
Fall Time	t _f				35		
DRAIN-SOURCE DIODE CHARACTERIST	TICS						
Forward Diode Voltage	V _{SD}	$V_{CS} = 0 V_{.}$ $T_{J} = 25^{\circ}C$			0.82	1.2	
		$V_{GS} = 0 V,$ $I_{J} = 1$ $I_{S} = 80 A$ $T_{J} = 1$	T _J = 125°C		0.69		V
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 43 A			73		ns
Reverse Recovery Charge	Q _{RR}				138		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Switching characteristics are independent of operating junction temperatures.

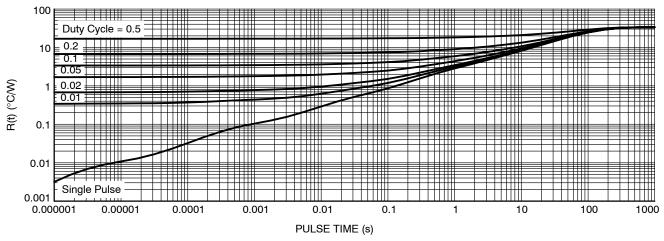
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



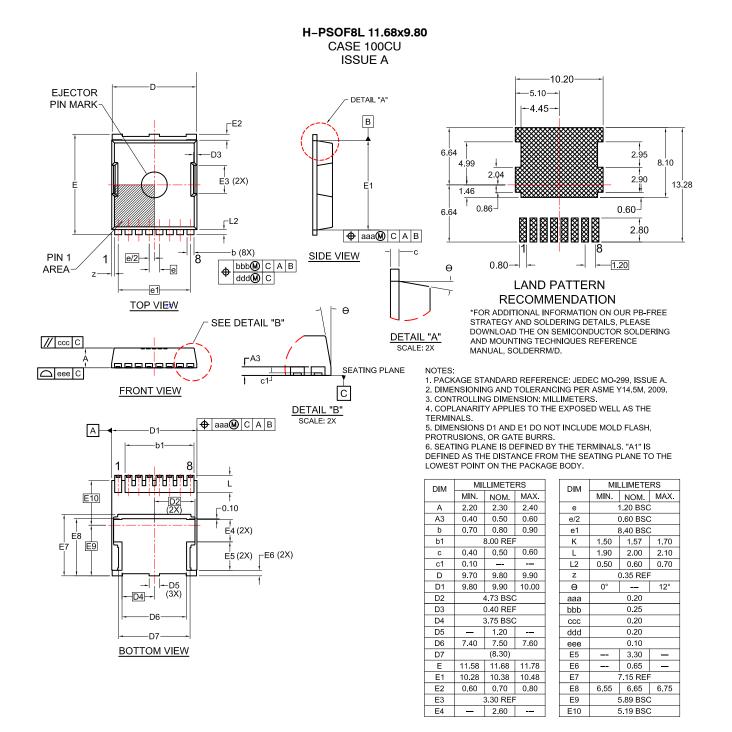


DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVBLS1D7N08H	1D7N08H	H–PSOF8L (Pb–Free)	2000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



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